Dual N-Channel Enhancement Mode Power MOSFET

DESCRIPTION

The JTM4840 uses advanced trench technology and design to provide excellent R_{DS(ON)} with low gate charge. It can be used in a wide variety of applications.

GENERAL FEATURES

●Vps =40V,lp =7.0A

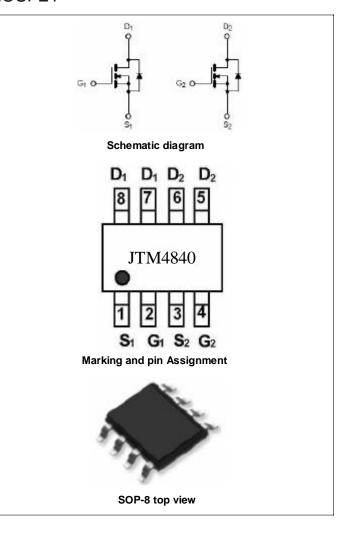
 $R_{DS(ON)} < 24m\Omega$ @ $V_{GS}=10V$

 $R_{DS(ON)} < 38m\Omega$ @ $V_{GS}=4.5V$

- High density cell design for ultra low Rdson
- Fully characterized Avalanche voltage and current

Application

- Power switching application
- Hard Switched and High Frequency Circuits
- Uninterruptible Power Supply



Package Marking And Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
JTM4840	JTM4840	SOP-8	Ø330mm	12mm	2500 units

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

3 (<u> </u>		
Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	40	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	lo	7	А
Drain Current-Continuous(T _A =100°C)	I _D (100℃)	5	А
Pulsed Drain Current	Ірм	30	Α
Maximum Power Dissipation	P _D	3	W
Operating Junction and Storage Temperature Range	TJ, TSTG	-55 To 150	$^{\circ}$

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	Rеја	42	℃W
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Electrical Characteristics (TA=25°C unless otherwise noted)

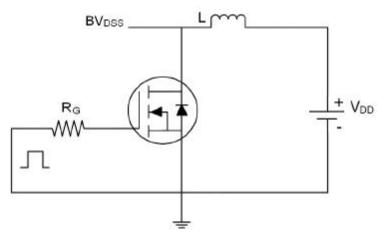
Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics							
Drain-Source Breakdown Voltage	BVpss	Vgs=0V lp=250µA	30	33	-	V	
Zero Gate Voltage Drain Current	IDSS	VDS=30V,VGS=0V	-	-	1	μA	
Gate-Body Leakage Current	Igss	Vgs=±20V,Vps=0V	-	-	±100	nA	
On Characteristics (Note 3)	<u> </u>		•				
Gate Threshold Voltage	V _{GS(th)}	VDS=VGS,ID=250µA	1	1.3	2.2	V	
Drain-Source On-State Resistance	Rds(on)	Vgs=10V, ID=7A	-	18.5	24	mΩ	
Dialif-Source Off-State Resistance	TOS(ON)	Vgs=4.5V, ID=5A	-	27	38		
Forward Transconductance	g FS	Vps=5V,lp=7A	5	-	-	S	
Dynamic Characteristics (Note4)	,		•	JI.			
Input Capacitance	Clss	Vps=15V,Vgs=0V, F=1.0MHz	-	2100	-	PF	
Output Capacitance	Coss		-	460	-	PF	
Reverse Transfer Capacitance	Crss	1 – 1.0IVII 12	-	230	-	PF	
Switching Characteristics (Note 4)	<u> </u>		•				
Turn-on Delay Time	t d(on)		-	20	-	nS	
Turn-on Rise Time	tr	VDD=10V,ID=7A	-	15	-	nS	
Turn-Off Delay Time	t _{d(off)}	$V_{GS}=10V,R_{GEN}=2.7\Omega$	-	60	-	nS	
Turn-Off Fall Time	t _f		-	10	-	nS	
Total Gate Charge	Qg	\/po_10\/ lp_7A	-	41	-	nC	
Gate-Source Charge	Qgs	V _{DS} =10V,I _D =7A, V _{GS} =10V	-	14	-	nC	
Gate-Drain Charge	Qgd	VGS=10V	-	11	-	nC	
Drain-Source Diode Characteristics							
Diode Forward Voltage (Note 3)	Vsp	Vgs=0V,Is=7A	-	-	1.2	V	
Diode Forward Current (Note 2)	ls		-	-	7	Α	

Notes:

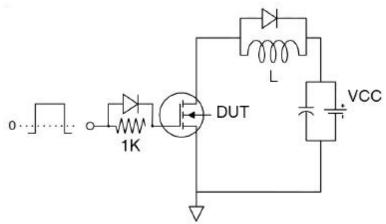
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production

Test circuit

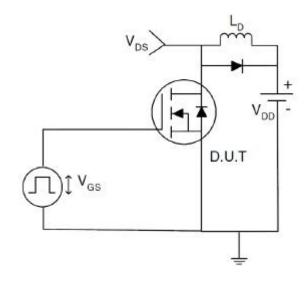
1) Eas test Circuits



2) Gate charge test Circuit:



3) Switch Time Test Circuit:



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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (Curves)

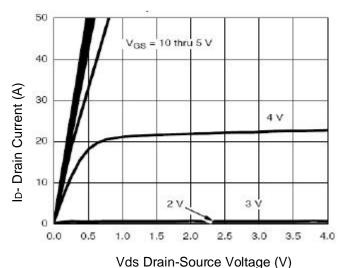
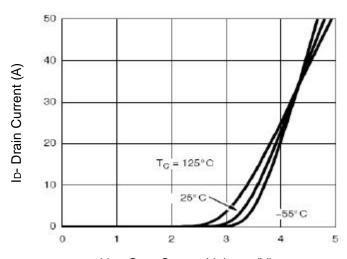


Figure 1 Output Characteristics



Vgs Gate-Source Voltage (V)

Figure 2 Transfer Characteristics

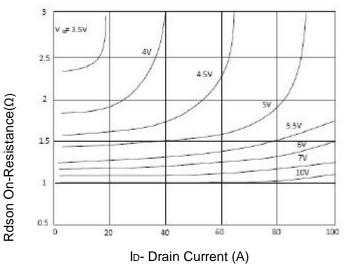


Figure 3 Rdson- Drain Current

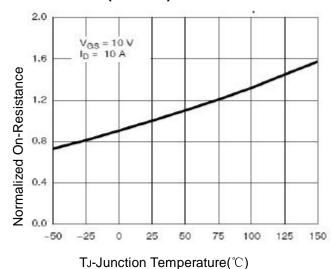


Figure 4 Rdson-JunctionTemperature

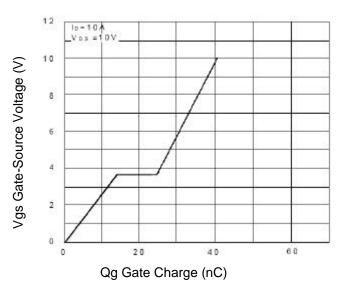


Figure 5 Gate Charge

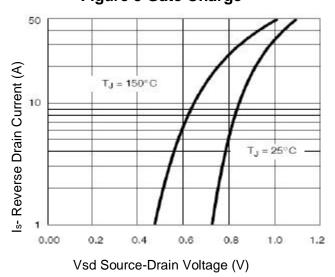


Figure 6 Source- Drain Diode Forward

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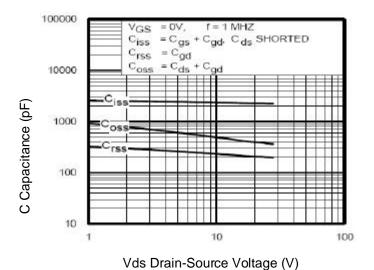
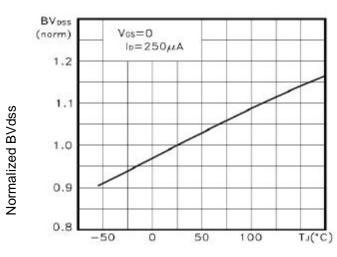


Figure 7 Capacitance vs Vds



TJ-Junction Temperature(°C)

Figure 9 BVpss vs Junction Temperature

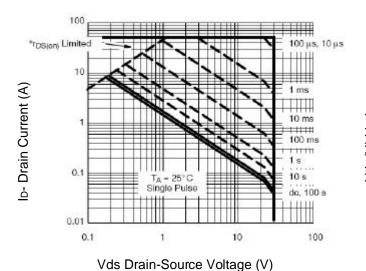


Figure 8 Safe Operation Area

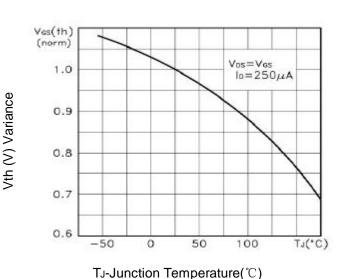
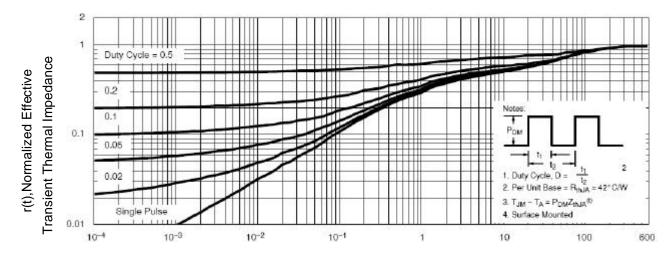


Figure 10 V GS(th) vs Junction Temperature



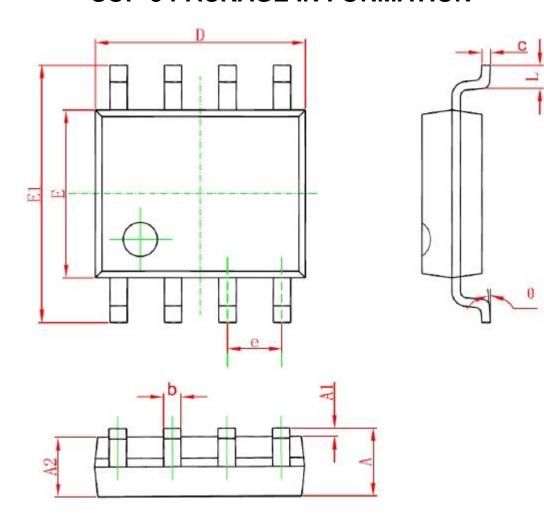
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance

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SOP-8 PACKAGE IN FORMATION



Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
	Min	Max	Min	Max	
Α	1. 350	1. 750	0. 053	0.069	
A1	0. 100	0. 250	0.004	0.010	
A2	1. 350	1. 550	0.053	0.061	
b	0. 330	0. 510	0.013	0. 020	
С	0. 170	0. 250	0.006	0.010	
D	4. 700	5. 100	0. 185	0. 200	
E	3. 800	4. 000	0. 150	0. 157	
E1	5. 800	6. 200	0. 228	0. 244	
е	1. 270 (BSC)		0.050	O (BSC)	
L	0. 400	1. 270	0.016	0.050	
θ	0°	8°	0°	8°	

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